



Article Ultrasonically Assisted Single Point Diamond Turning of Optical Mold of Tungsten Carbide

Zhanjie Li¹, Gang Jin^{1,*}, Fengzhou Fang², Hu Gong² and Haili Jia¹

- ¹ Tianjin Key Laboratory of High Speed Cutting and Precision Machining, Tianjin University of Technology and Education, Tianjin 300222, China; mtydhghd@126.com (Z.L.); hljia@tute.edu.cn (H.J.)
- ² State Key Laboratory of Precision Measuring Technology & Instruments, College of Precision Instrument and Opto-Electronics Engineering, Tianjin University, Tianjin 300072, China; fzfang@tju.edu.cn (F.F.); gonghu@tju.edu.cn (H.G.)
- * Correspondence: jgang625802@163.com

Received: 10 January 2018; Accepted: 8 February 2018; Published: 12 February 2018

Abstract: To realize high efficiency, low/no damage and high precision machining of tungsten carbide used for lens mold, a high frequency ultrasonic vibration cutting system was developed at first. Then, tungsten carbide was precisely machined with a polycrystalline diamond (PCD) tool assisted by the self-developed high frequency ultrasonic vibration cutting system. Tool wear mechanism was investigated in ductile regime machining of tungsten carbide. The cutter back-off phenomenon in the process was analyzed. The subsequent experimental results of ultra-precision machining with a single crystal diamond tool showed that: under the condition of high frequency ultrasonic vibration cutting, nano-scale surface roughness can be obtained by the diamond tool with smaller tip radius and no defects like those of ground surface were found on the machined surface. Tool wear mechanisms of the single crystal diamond tool are mainly abrasive wear and micro-chipping. To solve the problem, a method of inclined ultrasonic vibration cutting with negative rake angle was put forward according to force analysis, which can further reduce tool wear and roughness of the machined surface. The investigation was important to high efficiency and quality ultra-precision machining of tungsten carbide.

Keywords: tungsten carbide; lens mold; single point diamond turning (SPDT); ultrasonic vibration; Ductile regime; surface quality; wear

1. Introduction

Today, there is an increasing demand for aspheric lenses with the rapid development of the optical industry. The precision molding technique has become an important method for making optical components because of its high efficiency and high precision [1,2]. To undergo the process environment of high temperatures (400–800 °C) and large forces (1–10 kN) in the precision molding technique, the mold material should be heat-resistant and hard [3]. So far, ceramics have become the most promising material for precision molding, especially superfine tungsten carbide [4–6]. The molds for precision molding are typically ultra precision ground technique with a subsequent polishing [7–9], which is a process time-consuming process with low reproducibility. On the other hand, ultra-precision diamond turning is a mechanical manufacturing process that can achieve sub-nanometer level surface finishes (below 5 nm Ra) and sub-micrometer form accuracies (below 300 nm) on complex geometries [10]. Therefore, making optical molds with high efficiency, low/no damage and high precision can be realized by ultra-precision diamond turning [11]. The ultrasonic assisted ultra-precision diamond turning has already proved its potential for machining hard-to-cut materials such as steel [12], Co-Cr-Mo alloy [13], single-crystal silicon [14] and glass [15,16]. These publications demonstrate that ductile mode processing of tungsten carbide is possible [17–19].

In this paper, tungsten carbide will be ultra-precision machined using (Single Point Diamond Turning) SPDT assisted by a self-developed high frequency ultrasonic vibration cutting system. Critical depth of cut and wear mechanism will be investigated in ductile regime machining of tungsten carbide. Some phenomena and problems in the process will be analyzed, and then corresponding solutions will be put forward. This work has the extensive applicability and practical significance for ultra-precision machining tungsten carbide and optical molding industry.

2. Experimental Preparation

2.1. Ultrasonic Vibration Cutting System

As shown in Figure 1, the ultrasonic vibration cutting system used in this experiment consists of ultrasonic generator, power amplifier, horn, transducer and its clamping device, cutting tool and integrated micro height adjustment. A digital-tracking-mode ultrasonic generator with working frequency scope between 20 and 100 kHz was selected in order to ensure stable frequency and vibrating amplitude in the cutting process.



Figure 1. Schematic diagram of the ultrasonic vibration cutting system used in this experiment.

2.2. Modal Analysis of the Horn Using Finite Element Method

In order to avoid interference with tool setting gauge, ultrasonic horn made of quenched alloy steel was designed to an upward cutting end and a fixed end with vibration isolation groove. In order to analyze natural frequencies of the horn before experiment, a finite element analysis was carried out.

In the finite element analysis (FEA), material attributes were set as follows: young modulus was set to be 206 GPa, poison ratio was set to be 0.27, and mass density was set to be 7900 kg/m³. Plane 42 was chosen as the surface element and Solid 95 was chosen as the body element for the finite element model. The boundary condition was assumed to be isothermal [20]. Mesh tool was selected to control mesh size. Grid partition of the axial section and horn model were shown in Figures 2 and 3, respectively.



Figure 2. Axial section and grid partition.



Figure 3. Horn model and grid partition.

Modal analysis was set for the FEA and subspace was set for the extraction method. The extraction scope of frequencies was 30–90 kHz and the modal order number was set to be 10. Displacement constraints were imposed on upper-end of the horn spatial model, as shown in Figure 4.



Figure 4. Imposing constraints on upper-end of the horn.

Corresponding natural frequencies of the horn between 30 kHz and 90 kHz when resonance occurred are shown in Table 1. By observing vibration mode shapes of the horn, we know that axial resonance occurred at a frequency of 67.533 kHz. Vibration mode shape of the horn at frequency of 67.533 kHz is shown in Figure 5. No axial resonance occurred at other frequencies. The vibration mode shape of the horn at a frequency of 38.198 kHz is shown in Figure 6.

Table	1.	Natura	l frequ	iencies	of the	ultras	onic	horn.

Order	Natural Frequencies (kHz)
1	35.454
2	38.198
3	38.198
4	67.553
5	79.864

A sandwich transducer was fabricated using PZT8 piezoelectric ceramics, and the electrode slices was fabricated using beryllium copper.



Figure 5. Vibration mode shape of cylindrical horn at frequency of 67.533 kHz.



Figure 6. Vibration mode shape of cylindrical horn at frequency of 38.198 kHz.

2.3. Performance Testing of the Ultrasonic Vibration Cutting System

The no-load test results of the developed ultrasonic vibration cutting system showed that the cutting end reached resonance at a frequency of 64.769 kHz. The experimental result is in good agreement with the FEA result. The laser interference vibration measuring system (SIOS, SP-S, SP-S 120/500, SIOS MeBtechnik GmbH, Ilmenau, Germany) was adopted to track the amplitude of the cutting end. The corresponding amplitude between 1 and 14 μ m was measured at the voltage range of 0–400 V.

2.4. Experimental Condition and Plan

J05 tungsten carbide with a diameter of 16 mm was used in this experiment. Material properties of J05 were shown in Table 2. A precision cutting process with PCD tool (tip radius 1 mm, Shenzhen Yuhe Diamond Tools Co., Ltd., Shenzhen, China) was arranged at first due to lower surface smoothness of the specimen. Then, a natural single crystal diamond tool was used to ultra-precision cutting from the operator to the center of the workpiece along the *X*-axis direction. Both processes were performed with lubrication of light mineral oil (isopar H).

Name	Chemical Composition (Weight Percentage %)	Hardness	Grain Size (µm)	Density (g/cm ³)
J05	WC: 90 (±0.5%) Co.: 10 (±0.5%)	HRA:91.2–92.0 HRC:76.4–77.2	0.6	14.65

Table 2. Material properties of tungsten carbide.

As shown in Figure 7, the self-developed high frequency ultrasonic vibration cutting system was amounted on an ultra-precision lathe (Nanotech 250UPL, Moore Nanotechnology System, LLC, Keene, NH, USA). The tool setting and cutting processes were assisted by a real time monitoring system.



Figure 7. Schematic of the experiment system; (**a**) Cutting end; (**b**) Tool setting assisted by real time monitoring; (**c**) Ultrasonic generator and power amplifier.

2.5. Test Method

A white light interferometer was used to measure the surface topography and roughness of the machined workpiece. A 3D digital microscope was used to observe the topography of diamond tool wear.

3. Results and Analysis

3.1. Precision Machining Using PCD Tool and Results

The selected process parameters were as follows: the spindle rotation speed was set to be 100 rpm, the feed rate was set to be 1 mm/min, the depth of cut was set to be 3 μ m, the frequency for ultrasonic vibration cutting system was set to be 65 kHz and the vibrating amplitude adjusted by power amplifier was set to be 2 μ m.

The surface roughness of the machined workpiece is 173.56 nm and the surface topography, which reached the requirement for ultra-precision machining, is shown in Figure 8.



Figure 8. Surface topography and roughness of the workpiece machined by (polycrystalline diamond) PCD tool (Ra 173.56 nm).

3.2. Ultra-Precision Machining Using Natural Single Crystal Diamond Tool

To obtain nano-scale surface roughness, a diamond tool with a larger tip radius of 1.5 mm was adopted according to the geometrical factor. The selected process parameters were as follows: the spindle rotation speed was set to be 50 rpm, the feed rate was set to be 0.01 mm/min, the depth of cut was set to be 3 μ m, the frequency for ultrasonic vibration cutting system was set to be 65 kHz and the vibrating amplitude adjusted by power amplifier was set to be 2 μ m.

To ensure cutting in the ductile region, the trial cutting method was adopted to decide the cutting depth. As shown in Figure 9, a continuous and ribbon-like chip appeared at the cutting depth of 200 nm. Thus, the optimal cutting depth was determined.

<u>зоо</u> µm

Figure 9. Continuous and ribbon-like chip.

A back-off phenomenon happened when displacement distance of the diamond tool is 2 mm along X-axis. The corresponding surface topography of the machined workpiece is shown in Figure 10.



Figure 10. Back-off phenomenon of diamond tool and surface topography of the machined workpiece; (**a**) Surface roughness (Ra 4.72 nm) near the edge of workpiece; (**b**) Surface roughness (Ra 9.85 nm) before back-off phenomenon; (**c**) Surface roughness (Ra 17.3 nm) at back-off phenomenon; (**d**) Two-dimensional graph of back-off phenomenon.

Figure 10 showed that surface roughness of 4.72 nm was obtained near the edge of the workpiece when the diamond tool cut into the workpiece. Then, the roughness was changed to 9.85 nm after a longer cutting distance. Subsequently, the cutting process cannot proceed after back-off phenomenon occurred, as shown in Figure 10c,d.

The reason for the back-off phenomenon was assumed to be the hardness of tungsten carbide and the tool tip radius. The stress put on the diamond tool was so strong that the screw was loosened due to the longer contact between tool tip and workpiece. To reduce the stress, a diamond tool with a tip radius of 0.5 mm and lower spindle rotation speed were adopted. Figure 11a showed an obvious chipping on the tool edge (in the red elliptic mark). In Figure 11b, some small grooves were found in the wear land. So, wear mechanisms of the single crystal diamond tool were mainly abrasive wear and micro-chipping according to Figure 11 as well as surface topography of the machined workpiece, as shown in Figure 12. The surface roughness of the machined workpiece was Ra 2.55 nm when diamond tool cutting in a very short distance, but gradually rose to Ra 8.85 nm due to the longer cutting distance and tool wear. Surface quality was so good that no micro crack was found in the surface topography of the machined workpiece.



Figure 11. Wear of diamond tool with tip radius of 0.5 mm after cutting along X-axis with a distance of 1 mm (wear land width: 3.05μ m, wear land length: 44.61μ m); (**a**) Wear of rake face; (**b**) Wear of rear face.



Figure 12. Surface topography of the machined workpiece after cutting along *X*-axis with a distance of 1 mm by a diamond tool with tip radius of 0.5 mm; (**a**) Ra 2.55 nm when diamond tool cutting in a very short distance; (**b**) Ra 8.85 nm when diamond tool cutting in a distance of 1 mm.

3.3. Discussion

From the above experimental results, the strong stress and friction between tool tip and workpiece easily gave rise to an inclined angle δ of ultrasonic horn, which changed 0° of rake angle to a positive rake angle, as shown in Figure 13. In the cutting direction, cutting force F_1 and friction force f_1 existed

between flank surface of diamond tool and machined surface of workpiece at the stage of withdraw of the diamond tool from the chip. At the same time, in the feed direction, cuttingforce F_2 and friction force f_2 existed between the flank surface of the diamond tool and the transitional surface of the workpiece when the diamond tool left the chip (Figure 14). Therefore, diamond tool micro-chipping happened very easily due to the impact and alternating stress between the diamond tool and the workpiece [21].



Figure 13. Force analysis of ultrasonic horn; (**a**) Schematic diagram of force analysis; (**b**) Finite element analysis of the force on horn.



Figure 14. Schematic diagram of force analysis at the stage of diamond tool withdrawing; (**a**) Front view; (**b**) Top view.

In the inclined ultrasonic vibration cutting with negative rake angle, the diamond tool vibrated along the direction, as shown in Figure 15. On one hand, not only inclined cutting can decrease the impact force between diamond tool and workpiece, but also cutting with negative rake angle can enhance the strength of diamond tool. On the other hand, inclined cutting can avoid the contact and friction between the rear face of the diamond tool. At the same time, the separation between the diamond tool and the workpiece can help the cutting fluid reach the tool tip region, which can cool and lubricate the diamond tool completely. In this method, the size of both negative rake angle and included angle between vibrating direction and cutting direction had a great influence on surface roughness and tool wear.



Figure 15. Schematic diagram of inclined ultrasonic vibration cutting with negative rake angle; (**a**) Front view; (**b**) Top view.

To validate the proposed method and raise machining efficiency, an experiment was conducted under the following conditions: tip radius was 0.5 mm, light mineral oil (isopar H) was selected as lubrication, the spindle rotation speed was set to be 400 rpm, the feed rate was set to be 1 mm/min, the depth of cut was set to be 3 μ m, the frequency for ultrasonic vibration cutting system was set to be 65 kHz and the vibrating amplitude adjusted by power amplifier was set to be 2 μ m, inclination between rake face and *XOZ* plane was set to be about -5° , inclination between the center line of diamond tool and *Z*-axis was set to be about 5° .

Figure 16 showed surface topography of the machined workpiece using the proposed method. Surface roughness of the machined workpiece has been improved (Ra 1.82–6.2 nm) compared to that of conventional ultrasonic vibration cutting (Ra 2.55–8.85 nm, within a distance of 1 mm).



Figure 16. Surface topography of the machined workpiece using the proposed method; (**a**)Photo of the machined workpiece; (**b**) Ra 1.82 nm when diamond tool cutting in a very short distance; (**c**) Ra 6.2 nm when diamond tool cutting near the center of workpiece.

Figure 17 showed wear of the diamond tool using the proposed method. Wear has been improved (wear land width 0.78 μ m, wear land length 41.47 μ m) compared to that of conventional ultrasonic vibration cutting (wear land width 3.05 μ m, wear land length 44.61 μ m). Tool wear land of single crystal diamond tool was smaller and no obvious chipping was found on the tool edge.

Me	asure	a Result	Enlarge	Save as CS
1	No.	Measure 2 Points 2 Points	Result s 0 s 41	.78 um .47 um
		50	μm	

Figure 17. Wear of diamond tool with tip radius of 0.5 mm after cutting along *X*-axis with negative rake angle (wear land width: 0.78μ m, wear land length: 41.47μ m).

4. Conclusions

(1) A high frequency ultrasonic vibration cutting system was developed, and a tungsten carbide was precisely machined with a PCD tool assisted by the cutting system. Tool wear mechanism was investigated in ductile regime machining of tungsten carbide. The cutter back-off phenomenon in the process was analyzed.

(2) Tool wear mechanisms of both PCD and single crystal diamond tool were mainly abrasive wear and micro-chipping under the condition of high frequency ultrasonic vibration. The surface roughness of the machined workpiece gradually increased with the increased diamond tool wear. The size of tip radius had a great influence on diamond machinability of tungsten carbide. A nano-scale surface roughness can be obtained by using diamond tool with smaller tip radius and no defects were found on the machined surface.

(3) A method of inclined ultrasonic vibration cutting with negative rake angle was put forward according to force analysis, which can further reduce tool wear and roughness of machined surface. The above investigation is important to high efficiency and quality ultra-precision machining of tungsten carbide.

Acknowledgments: This work was supported by the National Natural Science Foundation of China (Grant No. 51320105009, 51305369, 51505336), the Tianjin City High School Science & Technology Fund Planning Project (Grant No. 2017KJ107) and the Tianjin Research Program of Application Foundation and Advanced Technology (Grant No. 15JCQNJC05200) and the Tianjin intelligent manufacturing major special project (Grant No. 15ZXZNGX00220 and 17ZXZNGX0080).

Author Contributions: Zhanjie Li and Fengzhou Fang conceived and designed the experiments; Zhanjie Li and Gang Jin performed the experiments; Gang Jin and Hu Gong analyzed the data; HailiJia contributed reagents/materials/analysis tools; Jin Gang and Zhanjie Li wrote the paper.

Conflicts of Interest: The authors declare no conflict of interest.

References

- 1. Brinksmeier, E.; Glaebe, R.; Osmer, J. Surface integrity demands of high precision optical molds and realization by a new process chain. *Procedia Eng.* **2011**, *19*, 40–43. [CrossRef]
- 2. Islam, M.; Martinez-Duarte, R. A sustainable approach for tungsten carbide synthesis using renewable biopolymers. *Ceram. Int.* 2017, *43*, 10546–10553. [CrossRef]

- 3. Ohmori, H.; Yoshida, K.; Hirai, S. Fabrication of SiC micro-lens mold for glass molding. *Int. J. Mach. Tool Manuf.* **2005**, *23*, 1324–1357.
- 4. Bulla, B.; Klocke, F.; Dambon, O. Influence of ultrasonic assisted processing on the ductility of binderless tungsten carbide. *Key Eng. Mater.* **2015**, *625*, 587–592. [CrossRef]
- 5. Bulla, B.; Klocke, F.; Dambon, O. Analysis on ductile mode processing of binderless, nano crystalline tungsten carbide through ultra-precision diamond turning. *J. Mater. Proc. Technol.* **2012**, 212, 1022–1029. [CrossRef]
- 6. Liu, K.; Li, X.P. Ductile cutting of tungsten carbide. J. Mater. Proc. Technol. 2001, 113, 348–354. [CrossRef]
- Brinksmeier, E.; Mutlugunes, Y.; Klocke, F. Ultra-precision grinding. CIRP Ann.-Manuf. Technol. 2010, 59, 652–671. [CrossRef]
- 8. Bifano, T.G.; Dow, T.; Scattergood, R. Ductile-regime grinding: A new technology for machining brittle materials. *J. ASME* **1991**, *113*, 184–189. [CrossRef]
- 9. Singh, H.; Pandey, O.P. Single step synthesis of tungsten carbide (WC) nanoparticles from scheelite ore. *Ceram. Int.* **2013**, *39*, 6703–6706. [CrossRef]
- 10. Ikawa, N.; Donaldson, R.R.; Komanduri, R. Ultra-precision metal cutting-the past, the present and the future. *CIRP Ann.-Manuf. Technol.* **1991**, *40*, 587–594. [CrossRef]
- 11. Blackley, W.S.; Scattergood, R.O. Ductile regime machining model for diamond turning of brittle materials. *Precis. Eng.* **1991**, *13*, 252–257. [CrossRef]
- 12. Moriwaki, T.; Shamoto, E. Ultra-precision diamond turning of stainless steel by applying ultrasonic vibration. *CIRP Ann.-Manuf. Technol.* **1991**, *40*, 559–562. [CrossRef]
- Song, Y.C.; Park, C.H.; Moriwaki, T. Mirror finishing of Co.–Cr–Mo alloy using elliptical vibration cutting. *Precis. Eng.* 2010, 34, 784–789. [CrossRef]
- 14. Yan, J.; Syoji, K.; Tamaki, J. Some observations on the wear of diamond tools in ultra-precision cutting of single-crystal silicon. *Wear* 2003, 255, 1380–1387. [CrossRef]
- 15. Fang, F.Z.; Liu, X.D.; Lee, L.C. Ultra-precision machining of brittle materials—A review of diamond-cutting brittle materials. *Nanotechnol. Precis. Eng.* **2003**, *1*, 38–47.
- 16. Gan, J.; Wang, X.; Zhou, M.; Ngoi, B.; Zhong, Z. Ultra-precision diamond turning of glass with ultrasonic vibration. *Int. J. Adv. Manuf. Technol.* **2003**, *21*, 952–955. [CrossRef]
- 17. Ma, C.X.; Wang, Y.; Shamoto, E.; Moriwaki, T. Influence of ultrasonic vibrated diamond tool on the critical depth of cut of brittle materials. *Chin. J. Mech. Eng.* **2005**, *41*, 198–202. [CrossRef]
- 18. Chen, W.H.; Lin, H.T.; Nayak, P.K.; Huang, J.L. Material properties of tungsten carbide–alumina composites fabricated by spark plasma sintering. *Ceram. Int.* **2014**, *40*, 15007–15012. [CrossRef]
- 19. Neo, W.K.; Kumar, A.S.; Rahman, M. A review on the current research trends in ductile regime machining. *Int. J. Adv. Manuf. Technol.* **2012**, *63*, 465–480. [CrossRef]
- Amini, S.; Soleimanimehr, H.; Nategh, M.J.; Abudollah, A.; Sadeghi, M.H. FEM analysis of ultrasonic-vibration-assisted turning and the vibratory tool. *J. Mater. Proc. Technol.* 2008, 201, 43–47. [CrossRef]
- 21. Jin, M.; Murakawa, M. Development of a practical ultrasonic vibration cutting tool system. *J. Mater. Proc. Technol.* **2001**, *113*, 342–347. [CrossRef]



© 2018 by the authors. Licensee MDPI, Basel, Switzerland. This article is an open access article distributed under the terms and conditions of the Creative Commons Attribution (CC BY) license (http://creativecommons.org/licenses/by/4.0/).